LoRa Sensor, Beacon Applications

LR62E LoRa transceiver module uses a Semtech SX1262 sub-GHz radio transceiver. An u.FL connector is on-board for external antenna. It is paired with Fanstel BM833, a low cost Nordic nRF52833 BLE 5.1 module. The Cortex M4F MCU in BM833 manages LR62E through SPI interface. BM833 GPIOs can be used for sensor data input or control output. Android OS app is available for field set up through Bluetooth interface.

BM833 + LR62E pair can be used in LoRaWAN™ application. LoRaWan stacks are not available from Fanstel.

Cloud Connection, LoRa Gateway

The 2nd application example is in a gateway for connecting to cloud servers(AWS, Microsoft, Google, Fanstel development server, etc.) through Ethernet, WiFi, or LTE network.

Fanstel BM833 BLE 5.1 module (Nordic nRF52833) manages LR62E through SPI interface.

LR62E Specifications:

- Semtech SX1262 transceiver
- Up to +22 dBm TX power (USA) at 902 to 928 MHz.
- Low power consumption: 4.2 mA at RX.

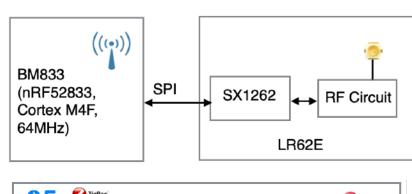
BM833 Brief Specifications:

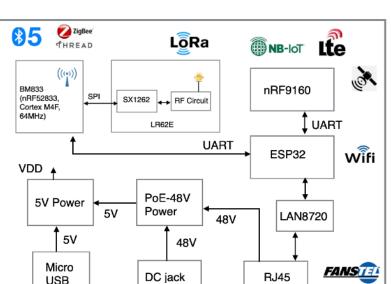
- Nordic nRF52 with ARM Cortex M4F.
- Serial Wire Debug (SWD)
- Over-the-Air (OTA) firmware update
- Flash/RAM: 512KB/128KB
- 42 General purpose I/O pins
- 12 bit/200KSPS ADC, 8 configurable channels with programmable gain.
- 3X SPI Master/Slave (8Mbps)
- 3X 4-channel pulse width modulator (PWM)
- 2X 2-wire Master/Slave (I²C compatible)
- UART (with CTS/RTS and DMA)
- 128-bit AES HW encryption
- 5 x 32 bits, 3 x 24 bits Real Time Counters (RTC)
- Available NFC-A tag interface for OOB pairing
- Certifications: FCC, ISED, CE, RCM, TELEC, QDID
- Operation temperature: -40°C to +105°C

Model Summaries

module	BM833	LR62E
Flash/RAM	512KB/128KB	
Size	10.2x15x1.9mm	10.2x15x1.9mm
GPIO	32	
Antenna	PCB Trace	u.FL
Range between 2 modules	700 meters at 1 Mbps, est.	50 Km, est.
Availability	Production	Sample

Open Source IoT Gateway supporting multiple radios, multiple networks









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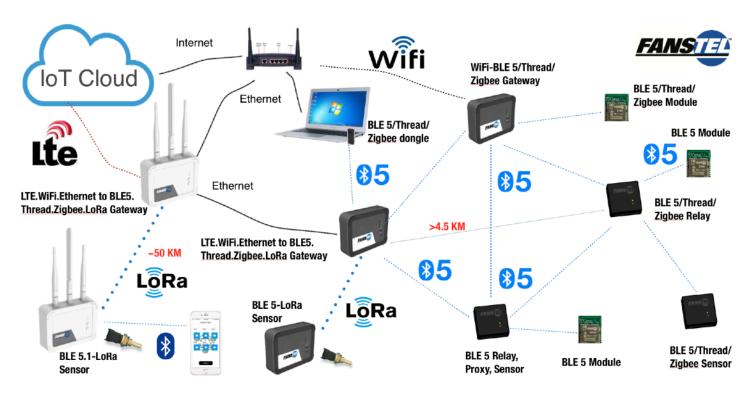
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1. Introduction

LR62E LoRa module with Semtech SX1262 transceiver are ideal for long range wireless applications. It can be paired with BM833 BLE module in LoRa sensor or beacon design. A smart phone can set up sensor or beacon easily through Bluetooth interface.

BM833 is powerful, highly flexible, ultra low power Bluetooth Low Energy (BLE) modules using Nordic nRF52833 SoCs. With an ARM Cortex[™] M4F MCU, available 512KB flash, 128KB RAM, embedded 2.4GHz multi-protocol transceiver, and an integrated antenna, it allows faster time to market with reduced development cost.



The second application example is in a gateway for connecting to cloud server. A LoRa sensor or beacon can be connected to a cloud server through Ethernet, WiFi, or LTE network.

It is possible to port LoRaWAN[™] stacks to Nordic nRF52 BLE SoCs. LoRaWAN[™] stacks are not available from Fanstel.



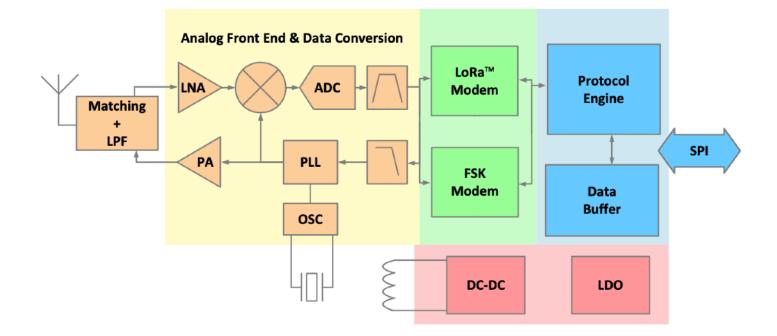
2. Product Overview

Semtech SX1262

Semtech SX1262 data sheets can be downloaded from this webpage.

https://www.fanstel.com/wirelessdocument

A block diagram is below.



LR62E module has an u.FL connector for external antenna. A BM832 or BT840F BLE module with Cortex M4F MCU manage LR62E through SPI interface.



Mechanical Drawings

The followings are mechanical drawings of LR62E, top view. Size of module is 10.2x15.0x1.9mm.

Library components for PADS and EAGLE can be downloaded from http://www.fanstel.com/download-document/

For other PCB layout tools, please download evaluation Gerber files and extract library component.

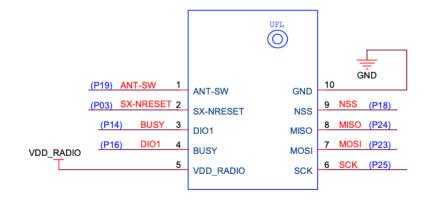


LR62E Pin Functions

The followings are LR62E pin assignment. Pin functions are in a table below. Please refer to Semtech SX1262 Product Specifications for detailed descriptions and features supported. It can be downloaded from:

https://www.fanstel.com/wirelessdocument

LR62E Pin Functions



LR62E		SX1262	
pin#	pin name	pin#	Descriptions
1	ANT-SW		Antenna switch
2	SX-NRESET	15	Reset signal, active low
3	BUSY	14	Busy indicator
4	DIO1	13	Multiple purpose Digital IO
5	VDD	1	DC input voltage, 1.8V to 3.7V
6	SCK	18	SPI clock
7	MOSI	17	SPI Slave input
8	MISO	16	SPI Slave Output
9	NSS	19	SPI Slave Select
10	GND	20	Ground



3. Evaluation Board

An evaluation board can be used to evaluate performance of module and to develop and test your firmware before an application-specific host board is developed. LR62E is paired with BM833 in the evaluation board.

Nordic Development Environment

Nordic Semiconductor provides a complete range of hardware and software development tools for the nRF52 Series devices. nRF52DK or nRF52840DK board is recommended for firmware development. Document and Software development tools can be downloaded by the following links.

Get started with Nordic chip and all online documents.

http://infocenter.nordicsemi.com/index.jsp?topic=/com.nordic.infocenter.nrf52/dita/nrf52/ development/nrf52_dev_kit.html&cp=1_1

Nordic SDK with many example projects.

https://developer.nordicsemi.com/nRF5_SDK/

Nordic development zone.

https://devzone.nordicsemi.com/tutorials/b/getting-started/posts/development-with-gcc-andeclipse

Programming the Nordic chip Download and install Nrf5x-Command-Line Tools <u>https://www.nordicsemi.com/eng/nordic/Products/nRF52840/nRF5x-Command-Line-Tools-</u> Win32/58850

Download and install nRFgo Studio

https://www.nordicsemi.com/eng/Products/2.4GHz-RF/nRFgo-Studio/

nRF52DK

The nRF52 DK is a versatile single board development kit for *Bluetooth*® low energy, ANT and 2.4GHz proprietary applications using the nRF52832 SoC. This kit supports development for the nRF52832 and nRF52810 SoC.

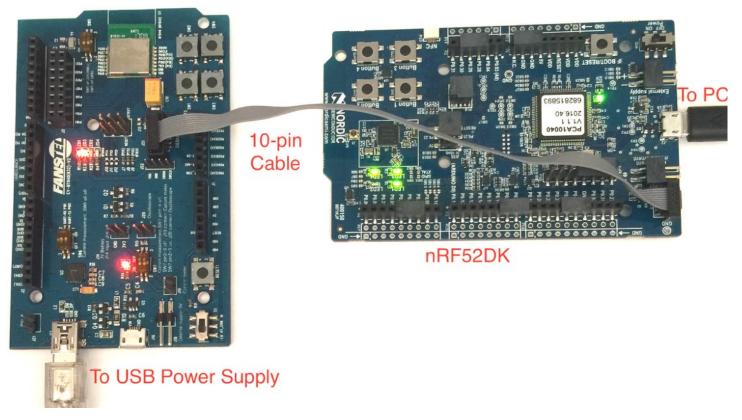
It supports the standard Nordic Software Development Tool-chain using SES, Keil, IAR and GCC. Program/ Debug options on the kit is Segger J-Link OB.

Loading Firmware into Evaluation Board Through a Nordic DK

Procedures to connect a Nordic DK to a Fanstel nRF52 module evaluation board.

- Connect Nordic nRF52DK debug out to Fanstel evaluation board debug in using the 10-pin flat cable as shown below.
- Connect Nordic nRF52DK to PC.
- Connect a DC power source to micro or mini USB port of evaluation board.





Check COM Port Connection

After connecting nRF52DK and an nRF52 sensor/evaluation board, you can see You can J-Link device and COM port on the PC control panel Device Manager.

Starting Nordic nRFgo

Open nRFgo Studio.

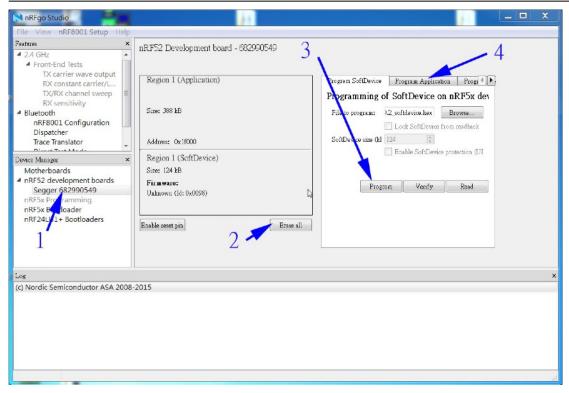
- 1. Click Segger 682990549 as in the example below.
- 2. Erase all if needed
- 3. Browse for Bootloader and program. After programming bootloader, you can use OTA for firmware update.
- 4. Browse for the SoftDevice and program.
- 5. Browse for the application hex file and program



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>	Computer		
>	🕳 Disk drives		
>	🥁 Display adapters		
>	DVD/CD-ROM drives		
>	Firmware		
>	🛺 Human Interface Devices		
>	The ATA/ATAPI controllers		
>	🏣 Intel(R) Dynamic Platform and Thermal Framework		
>	Explored Sector		
>	II Mice and other pointing devices		
>	Monitors		
>	P Network adapters		
>	Portable Devices		
	Ports (COM & LPT)		
	JLink CDC UART Port (COM4)		
	Print queues		
>	Processors		
>	Y Security devices		
>	Software devices		
>	Sound, video and game controllers		
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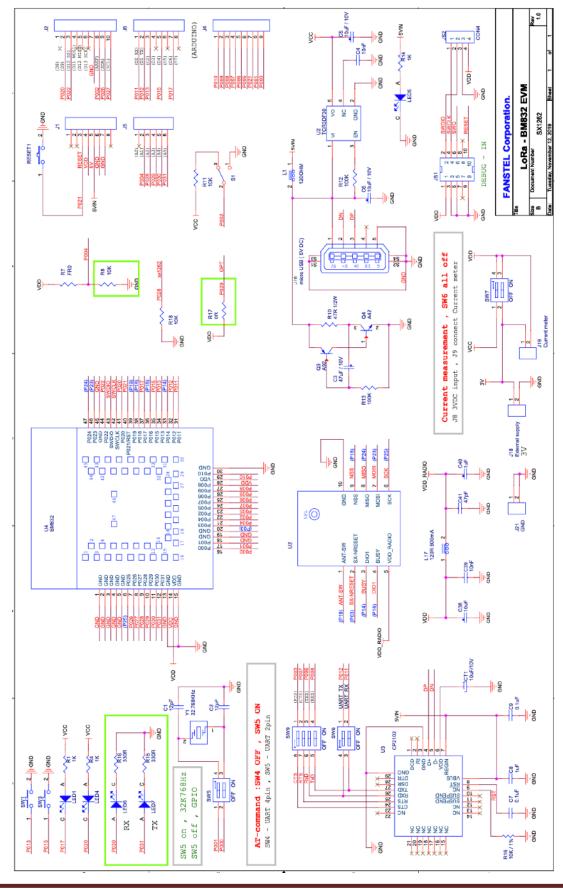


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Evaluation Board Schematic





for Battery Power Application

Standby current consumption is important for battery-powered product. We suggest adding a 32.768 kHz crystal and 2 capacitors as shown in the upper left corner of the evaluation board schematics. The 32MHz main clock won't be active at idle state to save power.

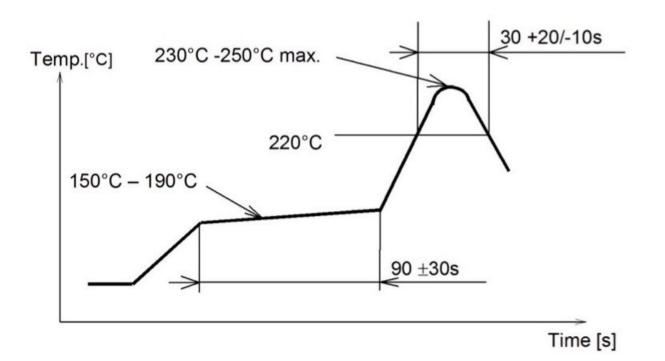
Two inductors required for DCDC converter are inside BM833 module. You can enable DCDC to lower power consumption.



4. Miscellaneous

Soldering Temperature-Time Profile for Re-Flow Soldering

Maximum number of cycles for re-flow is 2. No opposite side re-flow is allowed due to module weight.



Cautions, Design Notes, and Installation Notes

Failure to follow the guidelines set forth in this document may result in degrading of the product's functions and damage to the product.

Design Notes

- (1) Follow the conditions written in this specification, especially the control signals of this module.
- (2) The supply voltage has to be free of AC ripple voltage (for example from a battery or a low noise regulator output). For noisy supply voltages, provide a decoupling circuit (for example a ferrite in series connection and a bypass capacitor to ground of at least 47uF directly at the module).
- (3) This product should not be mechanically stressed when installed.
- (4)Keep this product away from heat. Heat is the major cause of decreasing the life of these products.
- (5) Avoid assembly and use of the target equipment in conditions where the products' temperature may exceed the maximum tolerance.
- (6)The supply voltage should not be exceedingly high or reversed. It should not carry noise and/or spikes.
- (7) this product away from other high frequency circuits.



Notes on Antenna and PCB Layout

(1)Don't use a module with internal antenna inside a metal case.

(2) For PCB layout:

- Avoid running any signal line below module whenever possible,
- No ground plane below antenna,
- If possible, cut-off the portion of main board PCB below antenna.

Installation Notes

- (1)Reflow soldering is possible twice based on the time-temperature profile in this data sheets. Set up the temperature at the soldering portion of this product according to this reflow profile.
- (2)Carefully position the products so that their heat will not burn into printed circuit boards or affect the other components that are susceptible to heat.
- (3)Carefully locate these products so that their temperatures will not increase due to the effects of heat generated by neighboring components.
- (4) If a vinyl-covered wire comes into contact with the products, then the cover will melt and generate toxic gas, damaging the insulation. Never allow contact between the cover and these products to occur.
- (5) This product should not be mechanically stressed or vibrated when reflowed.
- (6) If you want to repair your board by hand soldering, please keep the conditions of this chapter.
- (7) Do not wash this product.
- (8) Refer to the recommended pattern when designing a board.
- (9)Pressing on parts of the metal cover or fastening objects to the metal will cause damage to the unit.
- (10)For more details on LGA (Land Grid Array) soldering processes refer to the application note.

Usage Condition Notes

- (1)Take measures to protect the unit against static electricity. If pulses or other transient loads (a large load applied in a short time) are applied to the products, check and evaluate their operation before assembly on the final products.
- (2)Do not use dropped products.
- (3)Do not touch, damage or soil the pins.
- (4) Follow the recommended condition ratings about the power supply applied to this product.
- (5)Electrode peeling strength: Do not add pressure of more than 4.9N when soldered on PCB
- (6) Pressing on parts of the metal cover or fastening objects to the metal cover will cause damage.
- (7) These products are intended for general purpose and standard use in general electronic equipment, such as home appliances, office equipment, information and communication equipment.

Storage Notes

- (1)The module should not be stressed mechanically during storage.
- (2)Do not store these products in the following conditions or the performance characteristics of the product, such as RF performance will be adversely affected:



- Storage in salty air or in an environment with a high concentration of corrosive gas.
- Storage in direct sunlight
- Storage in an environment where the temperature may be outside the range specified.
- Storage of the products for more than one year after the date of delivery storage period.
- (3) Keep this product away from water, poisonous gas and corrosive gas.
- (4) This product should not be stressed or shocked when transported.
- (5) Follow the specification when stacking packed crates (max. 10).

Safety Conditions

These specifications are intended to preserve the quality assurance of products and individual components. Before use, check and evaluate the operation when mounted on your products. Abide by these specifications, without deviation when using the products. These products may short-circuit. If electrical shocks, smoke, fire, and/or accidents involving human life are anticipated when a short circuit occurs, then provide the following failsafe functions, as a minimum.

- (1)Ensure the safety of the whole system by installing a protection circuit and a protection device.
- (2)Ensure the safety of the whole system by installing a redundant circuit or another system to prevent a dual fault causing an unsafe status.

Other Cautions

- (1)This specification sheet is copyrighted. Reproduction of this data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices.
- (2)Do not use the products for other purposes than those listed.
- (3)Be sure to provide an appropriate failsafe function on your product to prevent an additional damage that may be caused by the abnormal function or the failure of the product.
- (4)This product has been manufactured without any ozone chemical controlled under the Montreal Protocol.
- (5)These products are not intended for other uses, other than under the special conditions shown below. Before using these products under such special conditions, check their performance and reliability under the said special conditions carefully to determine whether or not they can be used in such a manner.
 - In liquid, such as water, salt water, oil, alkali, or organic solvent, or in places where liquid may splash.
 - In direct sunlight, outdoors, or in a dusty environment
 - In an environment where condensation occurs.
 - In an environment with a high concentration of harmful gas.
- (6) If an abnormal voltage is applied due to a problem occurring in other components or circuits, replace these products with new products because they may not be able to provide normal performance even if their electronic characteristics and appearances appear satisfactory.
- (7) When you have any question or uncertainty, contact Fanstel.



Packaging

Production modules are delivered in reel, 1000 modules in each reel.

FCC LABEL

The Original Equipment Manufacturer (OEM) must ensure that the OEM modular transmitter must be labeled with its own FCC ID number. This includes a clearly visible label on the outside of the final product enclosure that displays the contents shown below. If the FCC ID is not visible when the equipment is installed inside another device, then the outside of the device into which the equipment is installed must also display a label referring to the enclosed equipment

The end product with this module may subject to perform FCC part 15 unintentional emission test requirement and be properly authorized.

This device is intended for OEM integrator only.



5. Revision HistoryJuly 2020, Ver. 0.90: The first draft copy



6. Contact Us

United States: Fanstel Corp. 7466 E. Monte Cristo Ave. Scottsdale AZ 85260 Tel. 1 480-948-4928 Fax. 1-480-948-5459 Email: info@fanstel.com Website: www.fanstel.com

Taiwan:

Fanstel Corp. 10F-10, 79 Xintai Wu Road Xizhu, New Taipei City, Taiwan 22101 泛世公司 臺灣省新北市汐止區新臺五路79號10樓之10, 22101 Tel. 886-2-2698-9328 Fax. 886-2-2698-4813 Email: info@fanstel.com Website: www.fanstel.com

China: Fanstel Technologies Corp. 11 Jiale Street Ping-Dih, Long-Gang, Shen Zhen, GD 518117 泛世康科技(深圳)有限公司 廣東省深圳市龍崗區坪地鎮佳樂街11號 Tel. 86-755-8409-0928 Fax. 86-755-8409-0973 QQ. 3076221086 Email: info@fanstel.com Website: www.fanstel.com

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